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PATENT NUMBER and
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U.S. UTILITY Patent Application

APPL. NUM 10082311	FILING DATE 02/26/2002	CLASS 438	SUBCLASS 557	GAU 2812	EXAMINER Burley
**APPLICANTS: Saikawa Takeshi; Maeno Ryohei; Okudaira Sadayuki; Saito Tetsuo; Tamaru Tsuyoshi; Ohmori Kazutoshi;					
**CONTINUING DATA VERIFIED:					
** FOREIGN APPLICATIONS VERIFIED: JAPAN 2001-140622 05/11/2001					
PG-PUB <input type="checkbox"/>		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>	
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged		Examiners's initials		ATTORNEY DOCKET NO XA-9635	
TITLE : Manufacturing method of semiconductor device					

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheet Dwg.	Figs. Dwg.
		Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner	
		PREPARED FOR ISSUE	
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